Refine Search

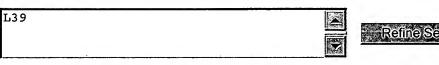
Search Results -

Terms	Documents
L38 and disk	130

Database:

US Pre-Grant Publication Full-Text Database
US Patents Full-Text Database
US OCR Full-Text Database
EPO Abstracts Database
JPO Abstracts Database
Derwent World Patents Index
IBM Technical Disclosure Bulletins

Search:









Search History

DATE: Tuesday, September 27, 2005 Printable Copy Create Case

Set Name side by side	Query	Hit Count	Set Name result set			
DB=USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ						
<u>L39</u>	L38 and disk	130	<u>L39</u>			
<u>L38</u>	L37 and (glass same temperature)	430	<u>L38</u>			
<u>L37</u>	L36 and 438/\$.ccls.	630	<u>L37</u>			
<u>L36</u>	L35	82763	<u>L36</u>			
DB=PGPB, USPT, USOC, EPAB, JPAB, DWPI, TDBD; PLUR=YES; OP=ADJ						
<u>L35</u>	glass same (calcium or barium or Ba or Sr or strontium or alkaline earth)	93227	<u>L35</u>			
<u>L34</u>	L1 and (polymer near6 soluble near7 alkaline)	14	<u>L34</u>			
<u>L33</u>	L26 and (polymer near6 soluble near7 alkaline)	0	<u>L33</u>			
<u>L32</u>	L31 and adhes\$	1	<u>L32</u>			
<u>L31</u>	"20050064681"	2	<u>L31</u>			
<u>L30</u>	L26 and (calcium or barium or Ba or Sr or strontium or alkaline earth)	37	<u>L30</u>			
<u>L29</u>	L22 and (calcium or barium or Ba or Sr or strontium or alkaline earth)	3	<u>L29</u>			
<u>L28</u>	L27 and (remov\$ near5 (disc or disk))	2	<u>L28</u>			

<u>L27</u>	L26 and (disk or disc or protective)	223	<u>L27</u>
<u>L26</u>	(438/459).ccls.	832	<u>L26</u>
<u>L25</u>	L20 and ((disc or disk) near2 compris\$)	0	<u>L25</u>
<u>L24</u>	L22 and ((disc or disk) near2 compris\$)	0	<u>L24</u>
<u>L23</u>	L22 and ((disk or disc) same (ceramic or polymer or support))	18	<u>L23</u>
<u>L22</u>	((disk or disc) near3 adher\$ near3 (semiconductor or wafer))	51	<u>L22</u>
<u>L21</u>	(disk near3 adher\$ near3 (semiconductor or wafer))	51	<u>L21</u>
<u>L20</u>	(disk near4 adher\$ near6 (semiconductor or wafer))	95	<u>L'20</u>
<u>L19</u>	(semiconduct\$ or wafer) same (disk\$ near4 protect\$) same (thin\$ or back grind\$)	21	<u>L19</u>
<u>L18</u>	(semiconduct\$ or wafer) same (disk\$) same (protective) same (thin\$ or back grind\$)	109	<u>L18</u>
<u>L17</u>	L1 and ((remov\$ near7 disk) same (solution or alkaline))	28	<u>L17</u>
<u>L16</u>	L1 and (remov\$ near7 disk)	276	<u>L16</u>
<u>L15</u>	L3 and (remov\$ near7 disk near8 (solution or alkaline))	2	<u>L15</u>
DB=U	JSPT, USOC, EPAB, JPAB, DWPI, TDBD; PLUR=YES; OP=ADJ		
<u>L14</u>	L13 and (remov\$ near7 disk)	19	<u>L14</u>
<u>L13</u>	L3 and (calcium or barium or Ba or Sr or strontium or alkaline earth)	146	<u>L13</u>
<u>L12</u>	L11	1	<u>L12</u>
DB=F	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ		
<u>L11</u>	L3 and (protective disk)	1	<u>L11</u>
<u>L10</u>	L3 and (protective disk same ceramic)	0	<u>L10</u>
<u>L9</u>	L8 and 438/\$.ccls.	5	<u>L9</u>
<u>L8</u>	L5 and L7	102	<u>L8</u>
<u>L7</u>	L3 and (calcium or barium or Ba or Sr or strontium or alkaline earth)	179	<u>L7</u>
<u>L6</u>	L5 and 438/\$.ccls.	22	<u>L6</u>
<u>L5</u>	L4 and (adhes\$ or polymer)	225	<u>L5</u>
<u>L4</u>	L3 and (calcium or Ca or barium or Ba or Sr or strontium or alkaline earth)	415	<u>L4</u>
<u>L3</u>	L2 and ceramic	881	<u>L3</u>
<u>L2</u>	(semiconduct\$ or wafer) same (disk\$) same (thin\$ or back grind\$)	3528	<u>L2</u>
<u>L1</u>	(semiconduct\$ or wafer) same (disk\$ or protective) same (thin\$ or back grind\$)	9856	<u>L1</u>

END OF SEARCH HISTORY